

N-Channel Enhancement Mode Field Effect Transistor

RC50N03D5

Product Summary

- V_{DS} 30V
- I_D 50A
- $R_{DS(ON)}$ (at $V_{GS}=10V$) < 8.5 mohm
- $R_{DS(ON)}$ (at $V_{GS}=4.5V$) < 1.3 mohm

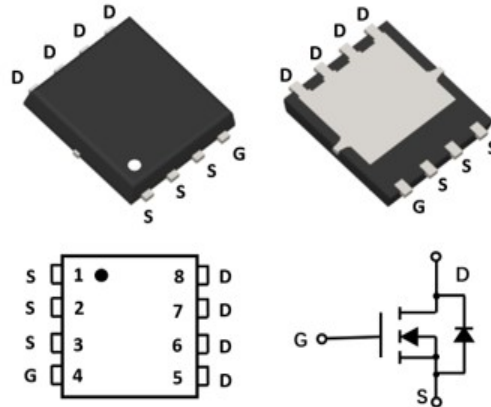
General Description

- Trench Power LV MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$

Applications

- High current load applications
- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

PDFN 5X6



■ Absolute Maximum Ratings ($T_A=25^{\circ}C$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	30	V
Gate-source Voltage		V_{GS}	± 20	V
Drain Current	$T_C=25^{\circ}C$	I_D	50	A
	$T_C=100^{\circ}C$		35	
Pulsed Drain Current ^A		I_{DM}	190	A
Total Power Dissipation	$T_C=25^{\circ}C$	P_D	42	W
	$T_C=100^{\circ}C$		21	
Single Pulse Avalanche Energy ^B		E_{AS}	225	mJ
Thermal Resistance Junction-to-Case ^C		$R_{\theta JC}$	3.6	$^{\circ}C/W$
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+175	$^{\circ}C$

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
RC50N03D5	F1	50N03	5000	10000	100000	13" reel

■ Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=30V, V_{GS}=0V$			1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.5	2.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=15A$		7	8.5	m Ω
		$V_{GS}=4.5V, I_D=15A$		10	13	
Diode Forward Voltage	V_{SD}	$I_S=20A, V_{GS}=0V$			1.2	V
Maximum Body-Diode Continuous Current	I_S				50	A
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{DS}=15V, V_{GS}=0V, f=1\text{MHz}$		2504		pF
Output Capacitance	C_{oss}			323		
Reverse Transfer Capacitance	C_{rss}			283		
Gate resistance	R_g	$F=1\text{MHz}$			3	Ω
Switching Parameters						
Total Gate Charge	Q_g	$V_{GS}=10V, V_{DS}=15V, I_D=20A$		54		nC
Gate-Source Charge	Q_{gs}			26		
Gate-Drain Charge	Q_{gd}			8.5		
Reverse Recovery Charge	Q_{rr}	$I_F=15A, di/dt=100A/\mu s$		10.2		ns
Reverse Recovery Time	t_{rr}			15		
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=10V, V_{DD}=20V, I_D=2A$ $R_{GEN}=3\Omega$		11		ns
Turn-on Rise Time	t_r			20		
Turn-off Delay Time	$t_{D(off)}$			41		
Turn-off fall Time	t_f			25		

A. Pulse Test: Pulse Width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

B. $R_{\theta JA}$ is the sum of the junction-to-Case and Case-to-ambient thermal resistance, where the Case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.

Typical Performance Characteristics

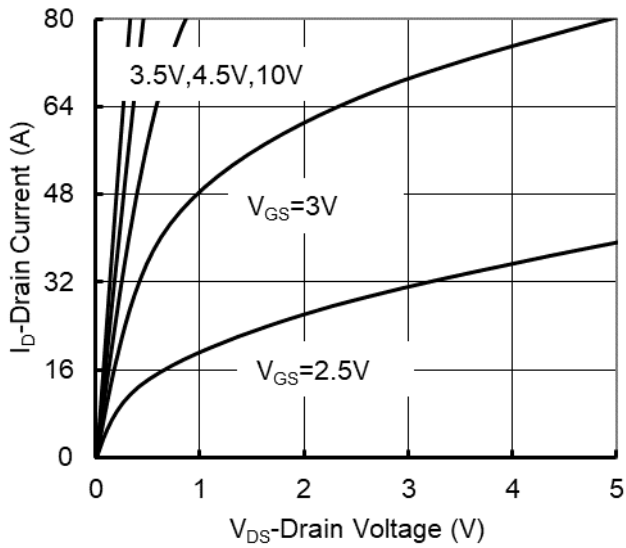


Figure1. Output Characteristics

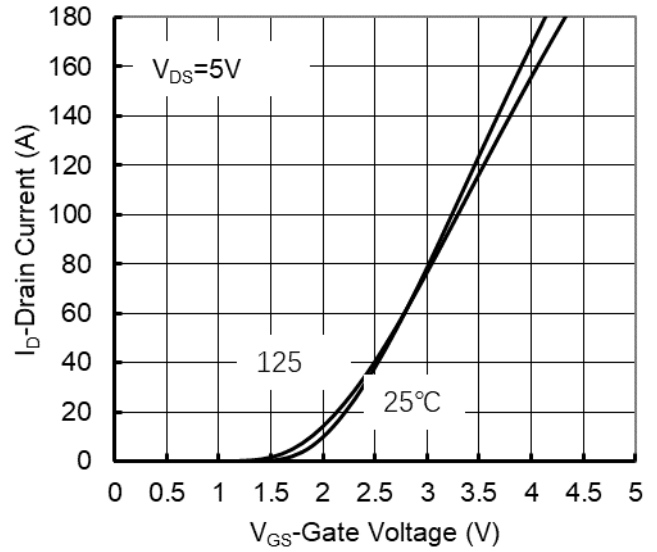


Figure2. Transfer Characteristics

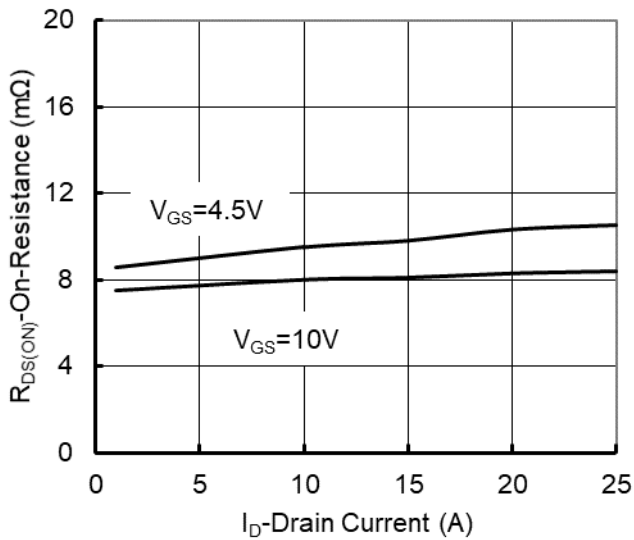


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

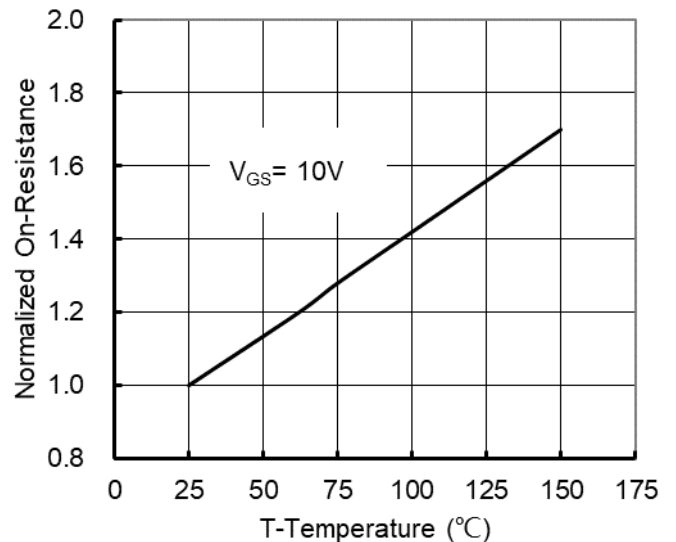


Figure 4: On-Resistance vs. Junction Temperature

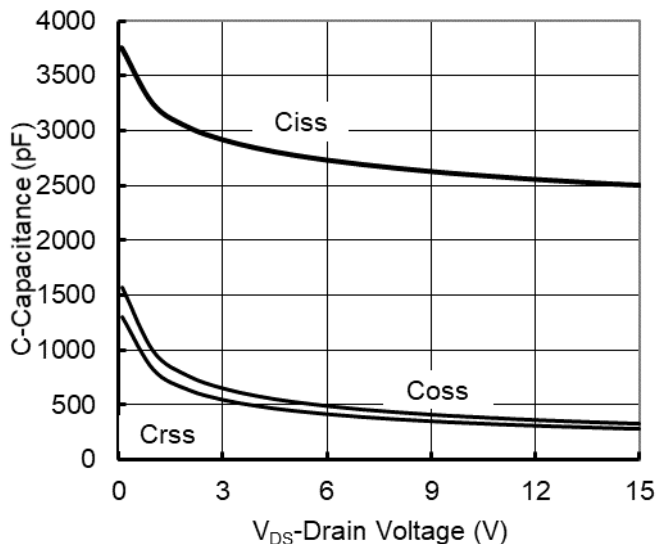


Figure5. Capacitance Characteristics

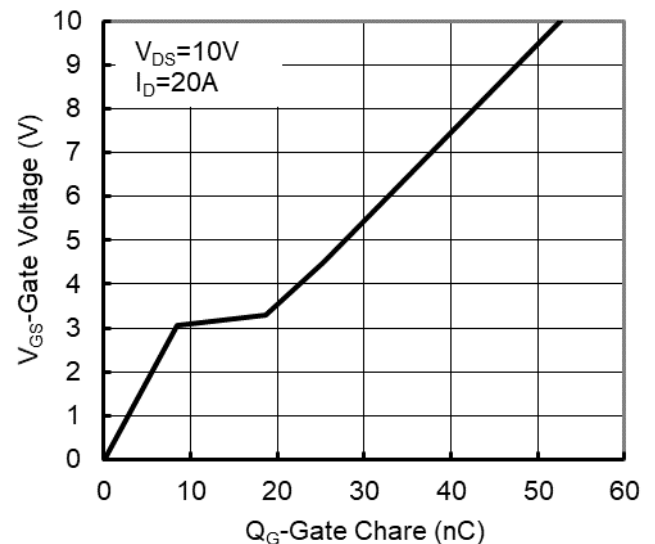


Figure6. Gate Charge

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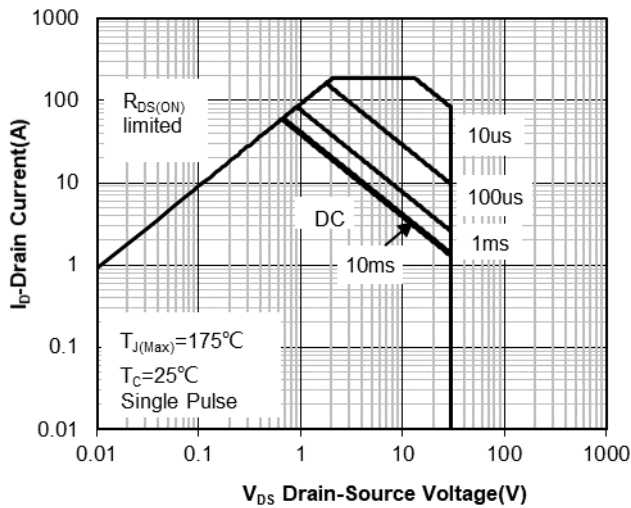


Figure7. Safe Operation Area

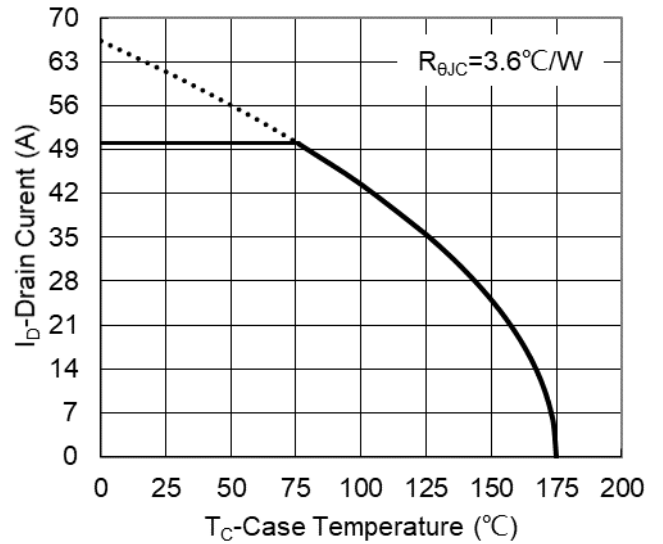


Figure8. Maximum Continuous Drain Current vs Case Temperature

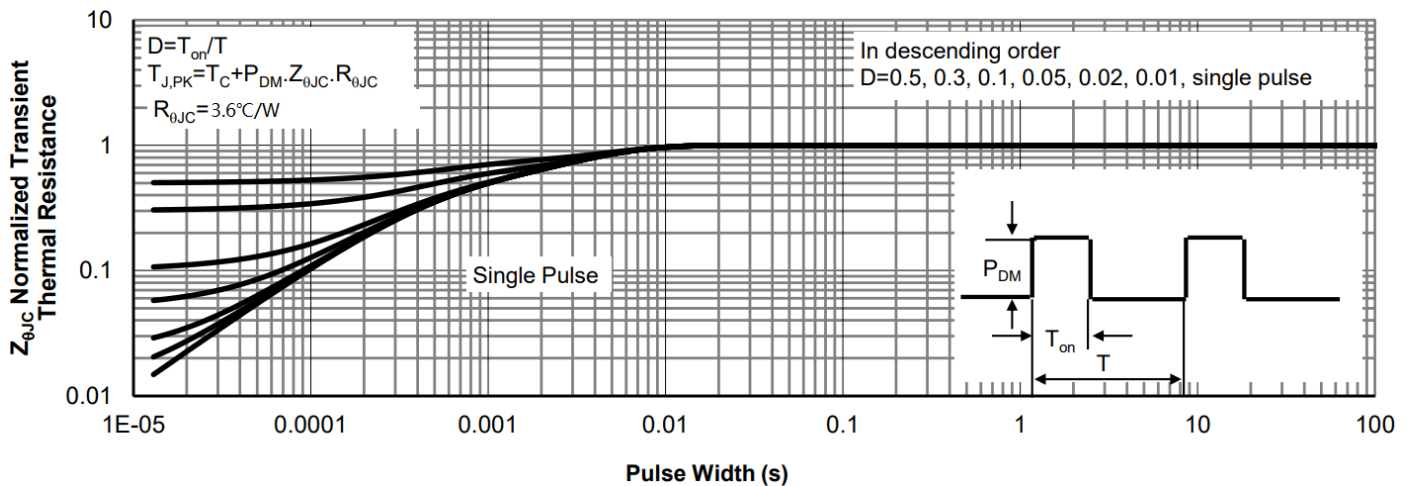
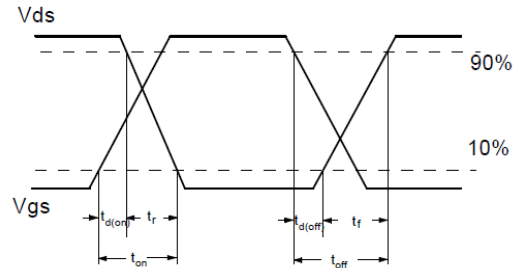
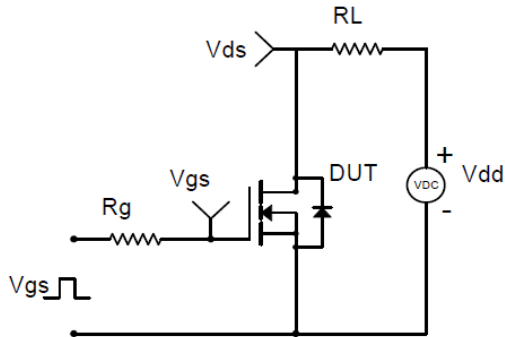


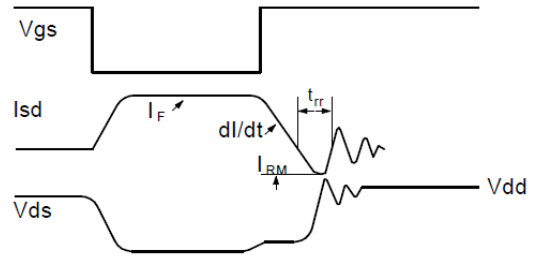
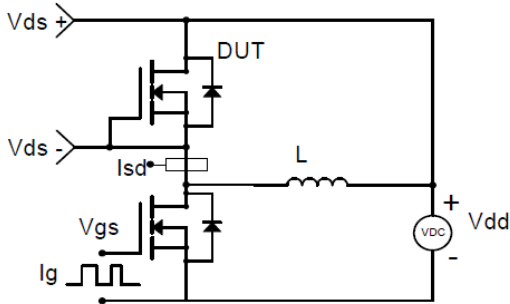
Figure9. Normalized Maximum Transient Thermal Impedance

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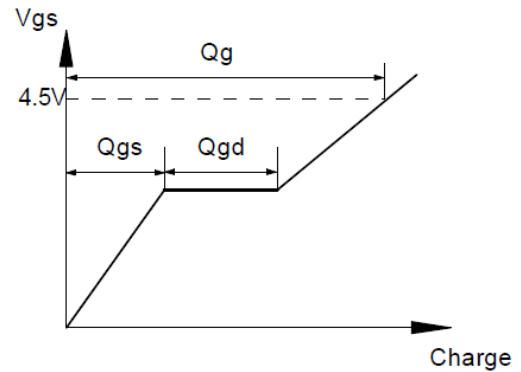
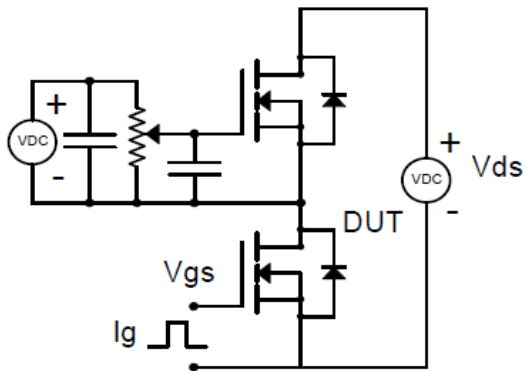
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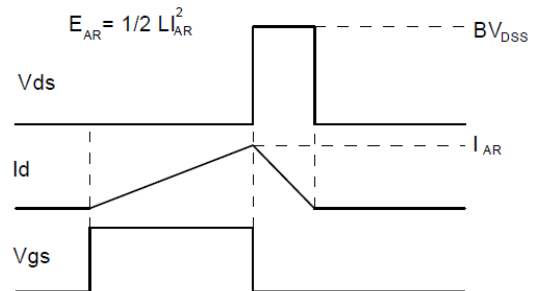
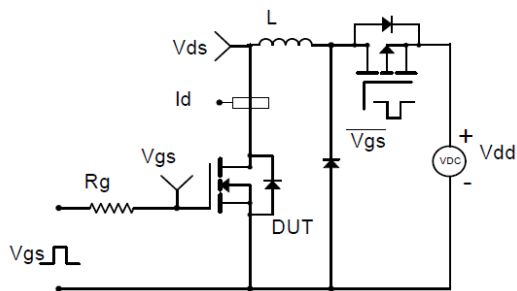
Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Gate Charge Test Circuit & Waveform



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

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■PDFN5X6 Package information

